PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hsiang-Lan Lung	04/26/2006

RECEIVING PARTY DATA

Name:	Macronix International Co., Ltd.
Street Address:	No. 16, Li-Hsin Road
Internal Address:	Science-Based Industrial Park
City:	Hsinchu
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 2

Property Type	Number
Application Number:	11381397
Application Number:	60763272

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: MXIC 1669-2

NAME OF SUBMITTER: Peter J. Su

Total Attachments: 2

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PATENT

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SOLE TO CORPORATE ASSIGNMENT

WHEREAS, the undersigned,

(1) Hsiang-Lan Lung 龍翔瀾 107 Town Green Drive Elmsford, New York 10523

hereinafter termed "Inventor", has invented certain new and useful improvements in

VERTICAL SIDE WALL ACTIVE PIN STRUCTURES IN A PHASE CHANGE MEMORY AND MANUFACTURING METHODS

above inver	ntion on 30 January 2006 as Ap	plication No.	es patent disclosing and identifying t 60/763,272, and has filed a non-	
provisional	application for a United States	Patent disclos	sing and identifying the above intent	tion
on	as Application No	, 0	R are filing such an application	
herewith, an application	nd have executed an oath or dec	laration of in	ventorship for such non-provisional	
	(1) the 26° day of Y	toril	, 2006;	

(hereinafter termed "applications"); and

WHEREAS, <u>Macronix International Co., Ltd.</u>, a corporation of <u>Taiwan</u>, having a place of business at <u>No. 16</u>, <u>Li-Hsin Road</u>, <u>Science-Based Industrial Park</u>, <u>Hsinchu</u>, <u>Taiwan R.O.C.</u> (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said applications and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventor (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee:

1. Said Inventor do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said applications and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

- 2. Said Inventor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignce.
- 3. The terms and covenants of this assignment shall inure to the benefit of said Assignce, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, the inventors' respective heirs, legal representatives and assigns.
- 4. Said Inventor hereby warrants and represents that said inventor has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor has executed and delivered this instrument to said Assignce as of the date written below.

HSIANG-JAN LUNG /

RECORDED: 05/03/2006

Date: 4/26/06